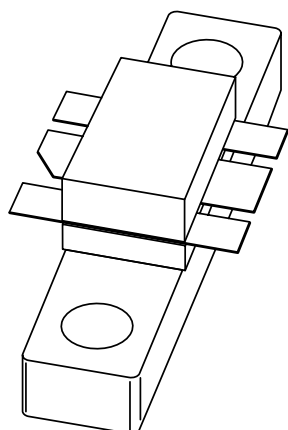


DATA SHEET



BLF544 UHF power MOS transistor

Product specification
Supersedes data of October 1992

1998 Jan 21

UHF power MOS transistor

BLF544

FEATURES

- High power gain
- Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability
- Designed for broadband operation.

APPLICATIONS

- Communication transmitters in the UHF frequency range.

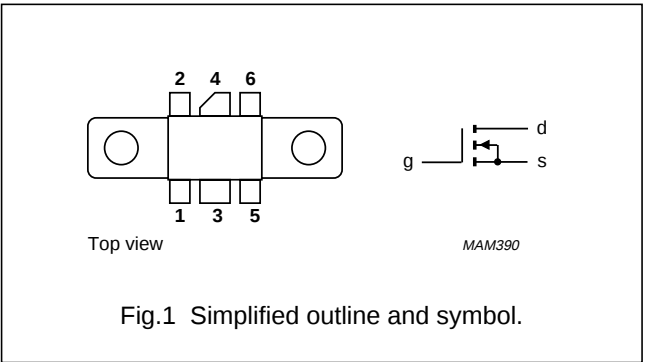
DESCRIPTION

N-channel enhancement mode vertical D-MOS power transistor encapsulated in a 6-lead, SOT171A flange package with a ceramic cap. All leads are isolated from the flange.

A marking code showing gate-source voltage (V_{GS}) information is provided for matched pair applications.

PINNING - SOT171A

PIN	SYMBOL	DESCRIPTION
1	s	source
2	s	source
3	g	gate
4	d	drain
5	s	source
6	s	source



QUICK REFERENCE DATA

RF performance at $T_h = 25\text{ }^{\circ}\text{C}$ in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V_{DS} (V)	P_L (W)	G_p (dB)	η_D (%)
CW, class-B	500	28	20	>11	>50
CW, class-B	960	28	20	typ. 7	typ. 50

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

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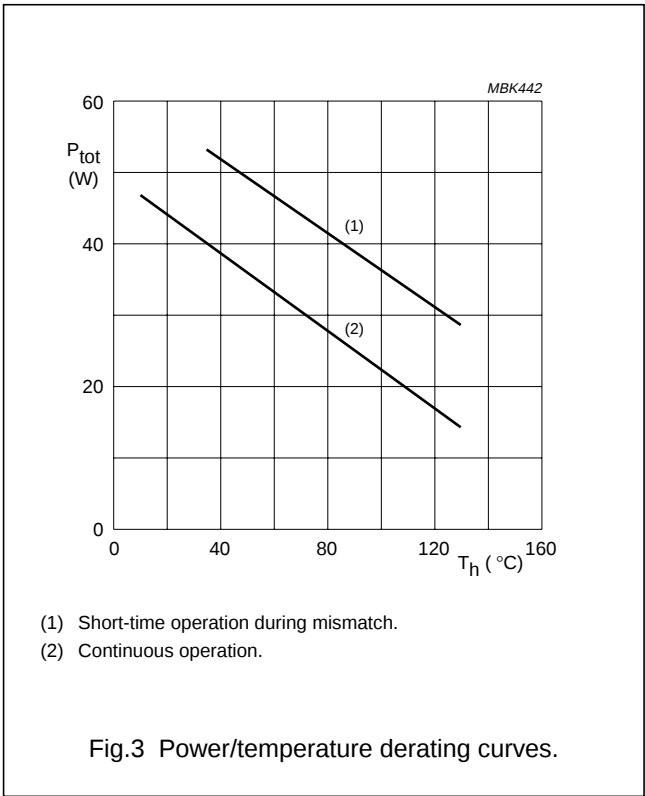
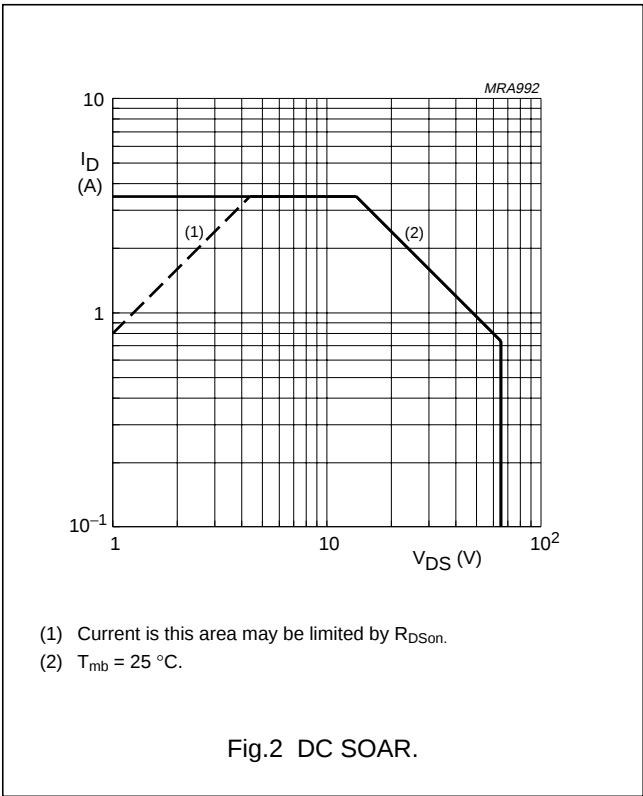
LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage		–	65	V
V_{GS}	gate-source voltage		–	± 20	V
I_D	drain current (DC)		–	3.5	A
P_{tot}	total power dissipation	$T_{mb} \leq 25\text{ }^{\circ}\text{C}$	–	48	W
T_{stg}	storage temperature		–65	150	$^{\circ}\text{C}$
T_j	junction temperature		–	200	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th\ j-mb}$	thermal resistance from junction to mounting base	3.7	K/W
$R_{th\ mb-h}$	thermal resistance from mounting base to heatsink	0.4	K/W



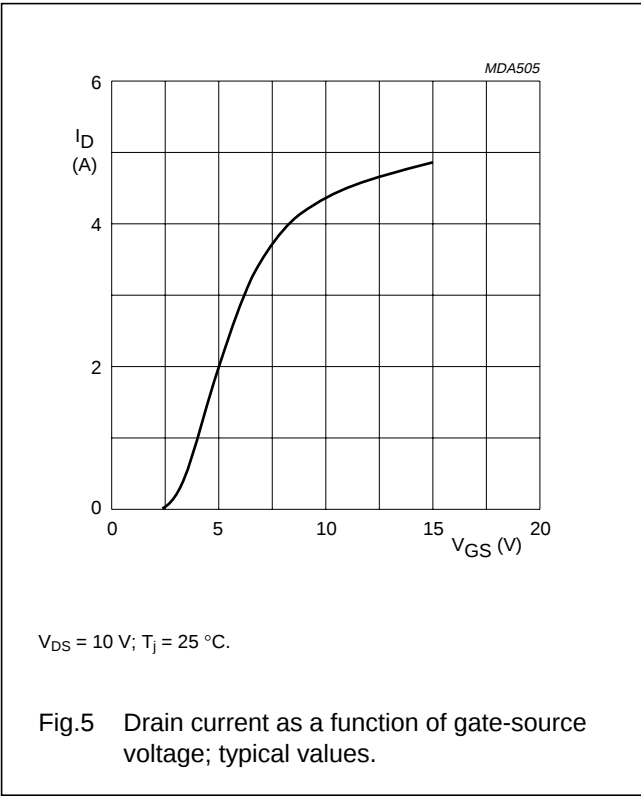
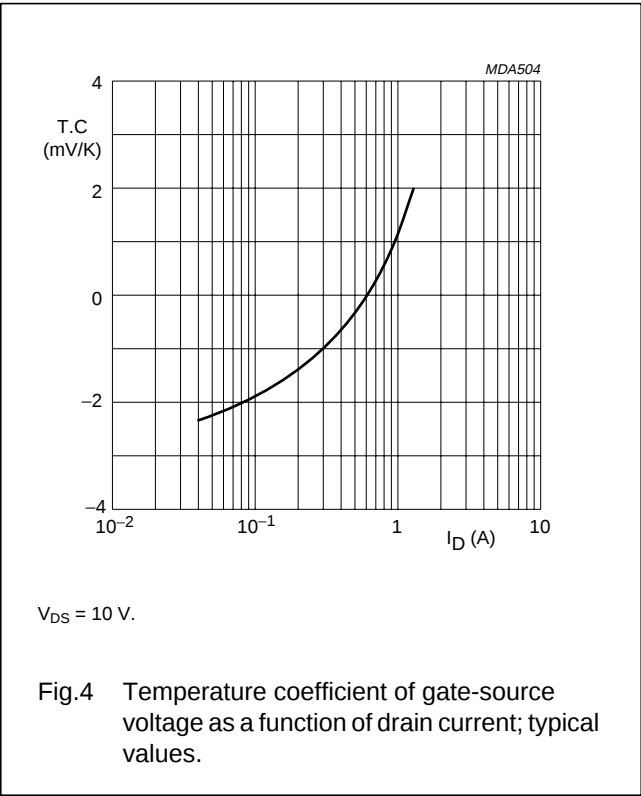
UHF power MOS transistor

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CHARACTERISTICS

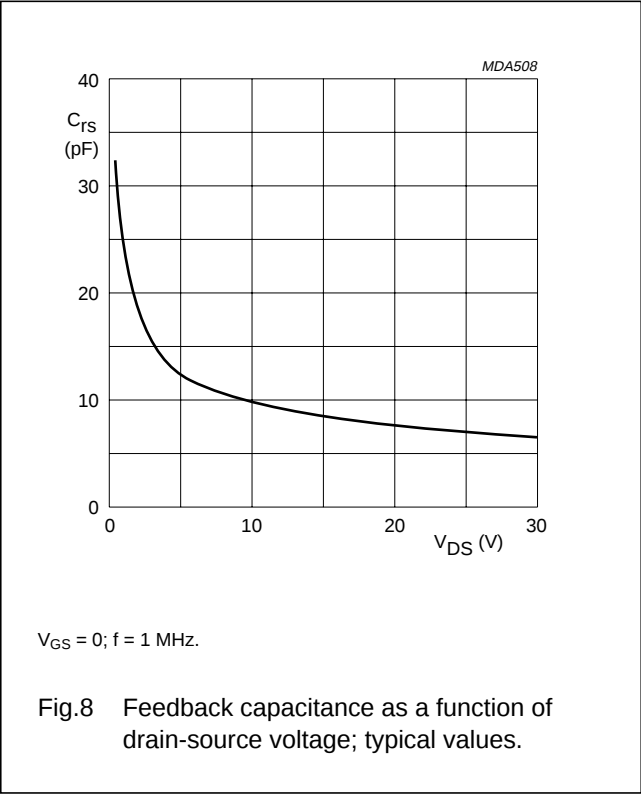
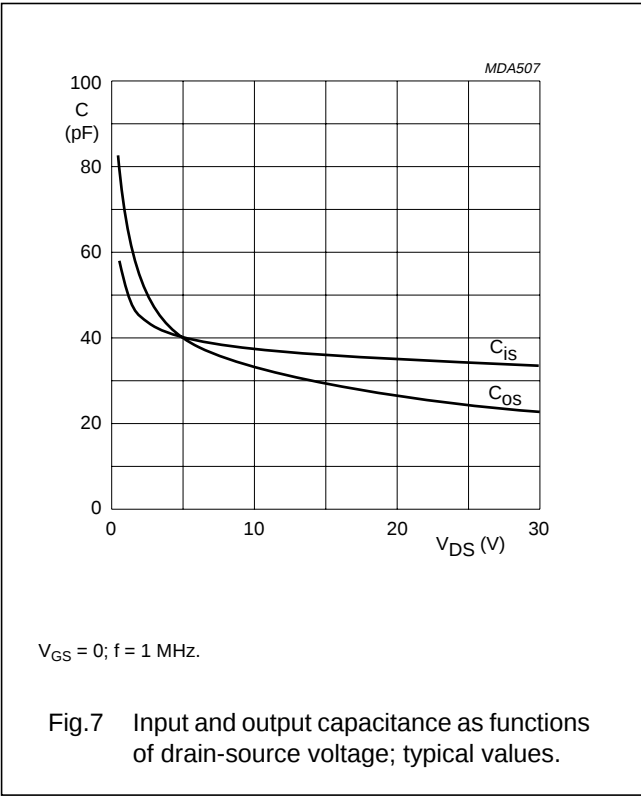
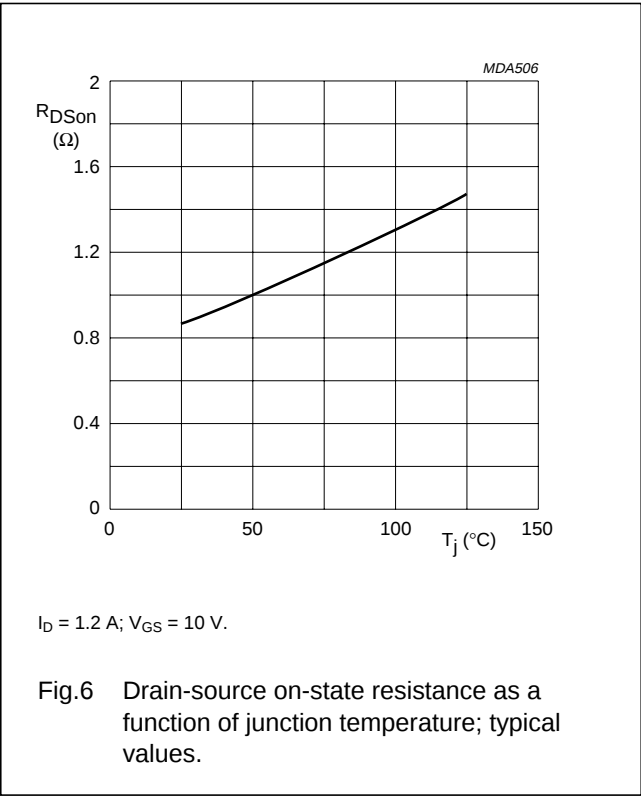
T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0; I _D = 10 mA	65	–	–	V
I _{DSS}	drain-source leakage current	V _{GS} = 0; V _{DS} = 28 V	–	–	1	mA
I _{GSS}	gate-source leakage current	V _{GS} = ±20 V; V _{DS} = 0	–	–	1	µA
V _{GSth}	gate-source threshold voltage	I _D = 40 mA; V _{DS} = 10 V	1	–	4	V
ΔV _{GSth}	gate-source voltage difference of matched pairs	I _D = 40 mA; V _{DS} = 10 V	–	–	100	mV
g _{fs}	forward transconductance	I _D = 1.2 A; V _{DS} = 10 V	600	900	–	mS
R _{DSon}	drain-source on-state resistance	I _D = 1.2 A; V _{GS} = 10 V	–	0.85	1.25	Ω
I _{DSX}	on-state drain current	V _{GS} = 15 V; V _{DS} = 10 V	–	4.8	–	A
C _{is}	input capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	32	–	pF
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	24	–	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	–	6.4	–	pF



UHF power MOS transistor

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UHF power MOS transistor

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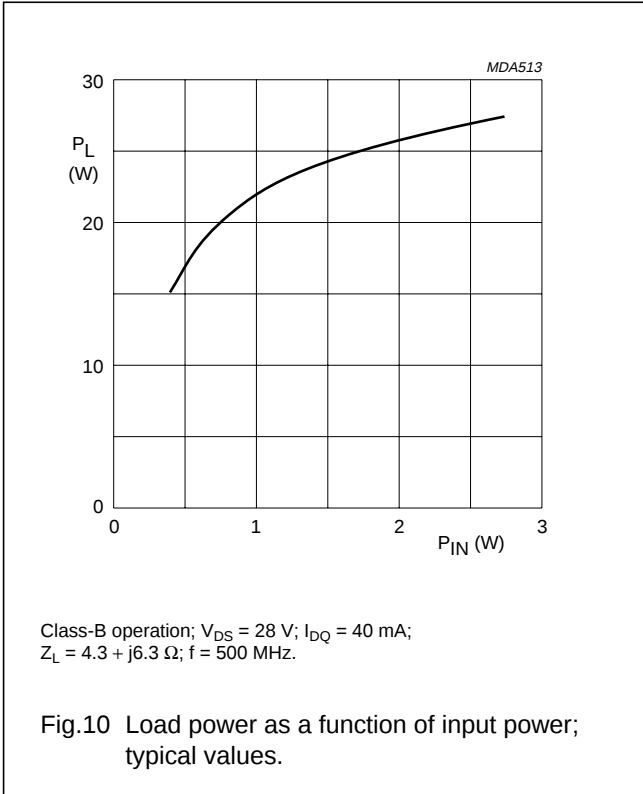
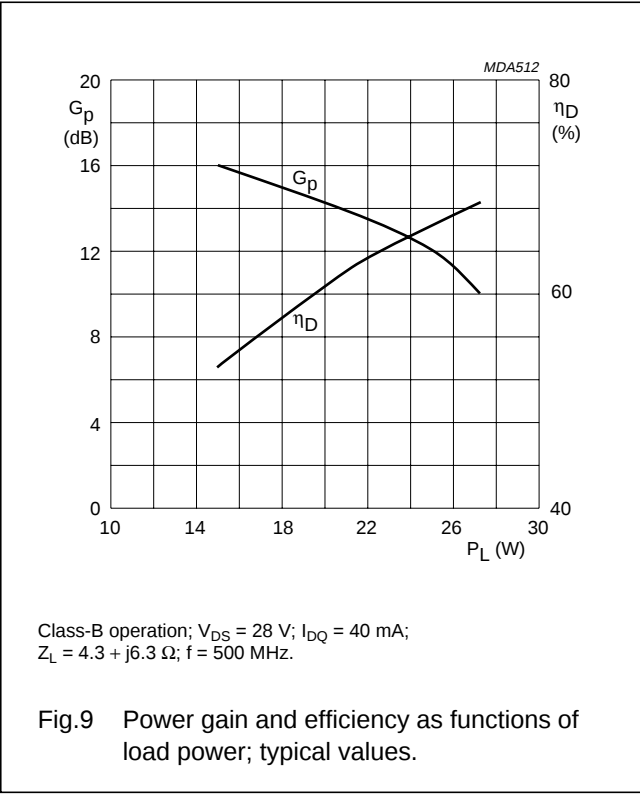
APPLICATION INFORMATION

$T_h = 25\text{ }^{\circ}\text{C}$; $R_{th\text{ mb-h}} = 0.4\text{ K/W}$ unless otherwise specified.
RF performance in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _{DQ} (mA)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	500	28	40	20	>11 typ. 14	>50 typ. 60
CW, class-B	960	28	40	20	typ. 7	typ. 50
CW, class-B	960	24	40	15	typ. 7	typ. 50

Ruggedness in class-B operation

The BLF544 is capable of withstanding a full load mismatch corresponding to VSWR = 50 : 1 through all phases under the following conditions: $V_{DS} = 28\text{ V}$; $f = 500\text{ MHz}$ at rated output power.



UHF power MOS transistor

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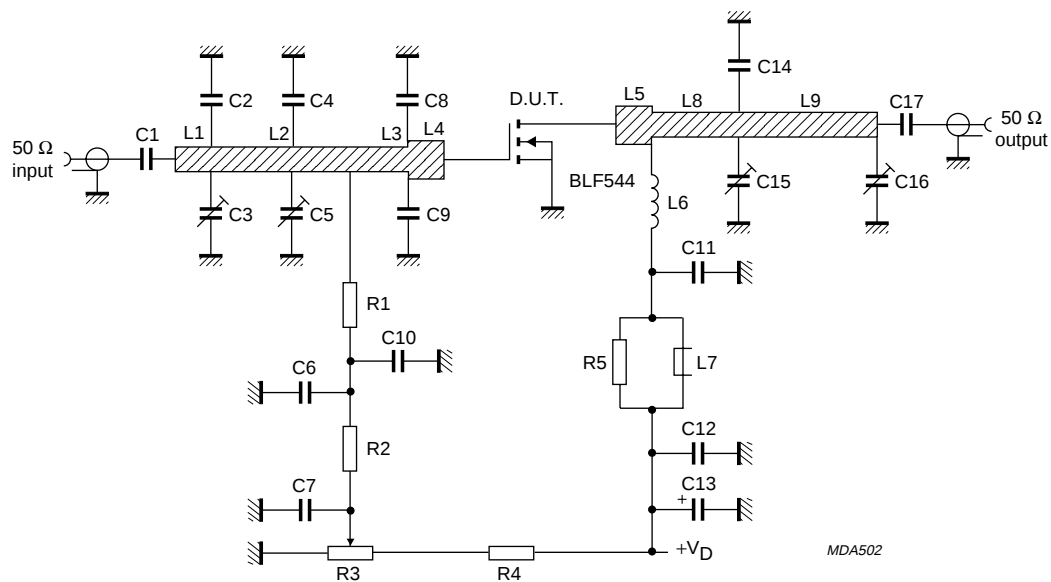
 $f = 500 \text{ MHz}$

Fig.11 Test circuit for class-B operation.

UHF power MOS transistor

BLF544

List of components (see Figs 11 and 12).

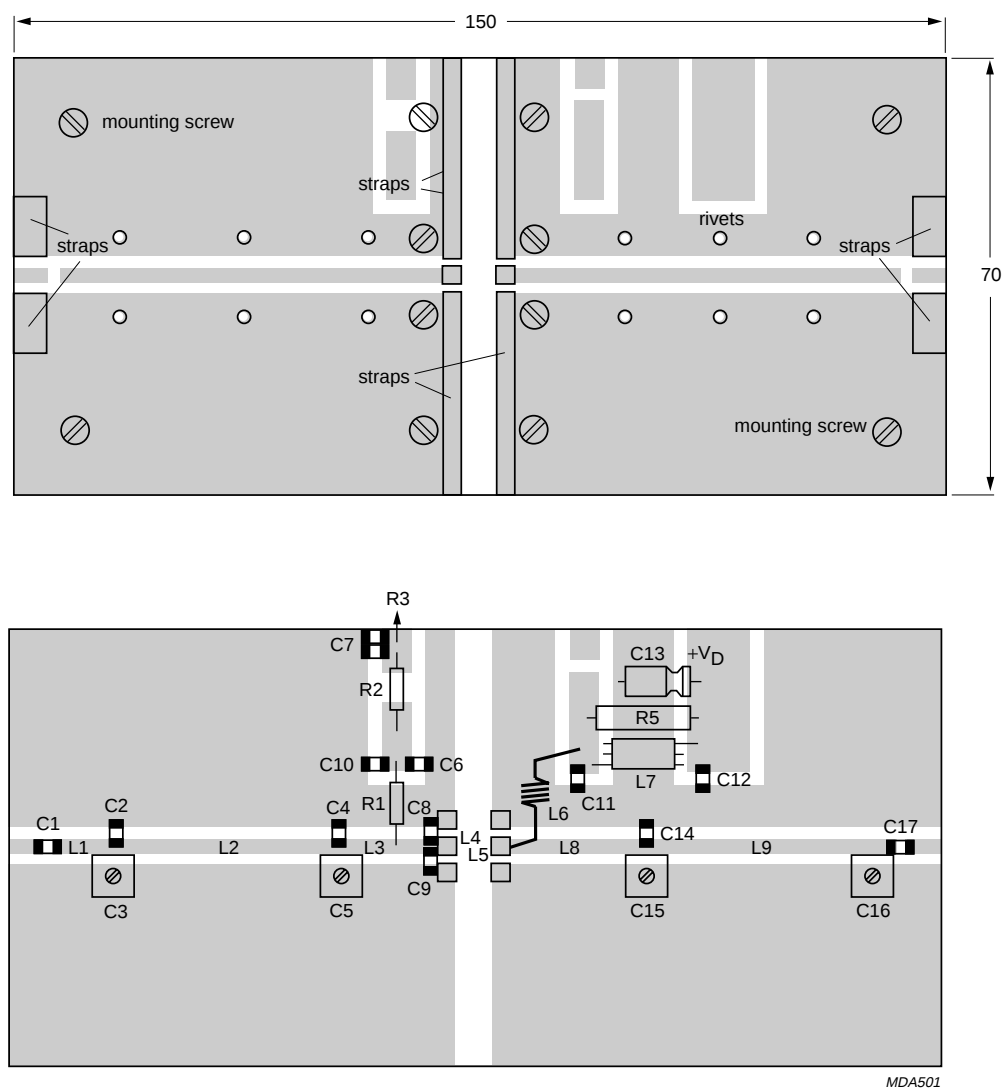
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C6, C11, C17	multilayer ceramic chip capacitor; note 1	390 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C3, C5	film dielectric trimmer	2 to 9 pF		2222 809 09002
C4	multilayer ceramic chip capacitor; note 2	27 pF; 50 V		
C7	multilayer ceramic chip capacitor	2 × 100 nF in parallel; 50 V		2222 852 47104
C8, C9	multilayer ceramic chip capacitor; note 2	39 pF		
C10, C12	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C13	electrolytic capacitor	4.7 µF; 63 V		2222 030 38478
C14	multilayer ceramic chip capacitor; note 1	20 pF; 500 V		
C15, C16	film dielectric trimmer	2 to 18 pF		2222 809 09003
L1	stripline note 3	50 Ω	9.5 × 2.5 mm	
L2	stripline note 3	50 Ω	34.5 × 2.5 mm	
L3	stripline note 3	50 Ω	17.5 × 2.5 mm	
L4, L5	stripline note 3	42 Ω	3 × 3 mm	
L6	4 turns enamelled 0.8 mm copper wire	31 nH	length 7.5 mm int. dia. 3 mm leads 2 × 5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L8	stripline note 3	50 Ω	22 × 2.5 mm	
L9	stripline note 3	50 Ω	39.5 × 2.5 mm	
R1, R2	0.4 W metal film resistor	1 kΩ		2322 151 11002
R3	10 turns cermet potentiometer	50 kΩ		
R4	0.4 W metal film resistor	140 kΩ		2322 151 11404
R5	1 W metal film resistor	10 Ω		2322 153 51009

Notes

1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
3. The striplines are on a double copper-clad printed circuit board, with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness $\frac{1}{32}$ inch.

UHF power MOS transistor

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MDA501

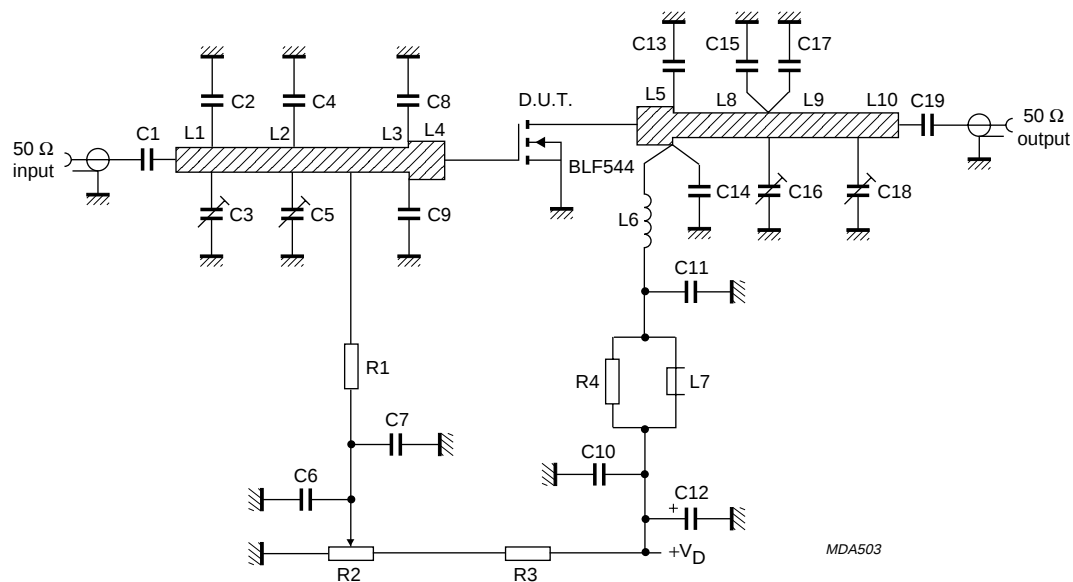
Dimensions in mm.

The circuit and components are situated on one side of the printed circuit board, the other side being fully metallized, to serve as a ground plane. Earth connections are made by means of copper straps and hollow rivets for a direct contact between upper and lower sheets.

Fig.12 Component layout for 500 MHz class-B test circuit.

UHF power MOS transistor

BLF544



f = 960 MHz.

Fig.13 Test circuit for class-B operation.

UHF power MOS transistor

BLF544

List of components (see Figs 12 and 13)

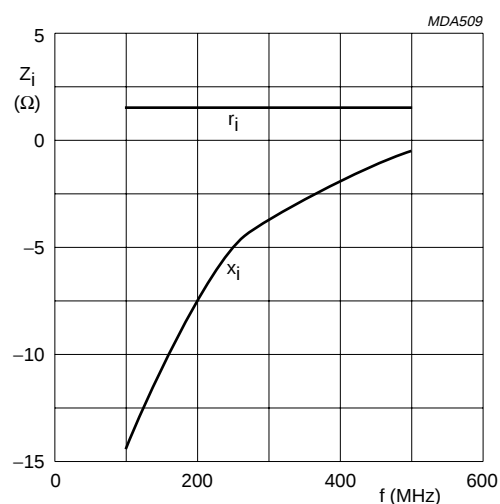
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1	multilayer ceramic chip capacitor; note 1	68 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	1.6 pF; 50 V		
C3, C5, C16, C18	film dielectric trimmer	1.4 to 5.5 pF		2222 809 09001
C4	multilayer ceramic chip capacitor; note 2	1 pF; 50 V		
C6	multilayer ceramic chip capacitor	10 nF; 50 V		2222 852 47103
C7, C11	multilayer ceramic chip capacitor; note 1	56 μ F; 500 V		
C8, C9, C15, C17	multilayer ceramic chip capacitor note 2	6.8 μ F; 50 V		
C10	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C12	electrolytic capacitor	4.7 μ F; 63 V		2222 030 38478
C13	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C14	multilayer ceramic chip capacitor; note 2	18 pF; 50 V		
C19	multilayer ceramic chip capacitor; note 1	62 pF; 500 V		
L1, L8	stripline; note 3	50 Ω	6 $\times$ 2.5 mm	
L2	stripline; note 3	50 Ω	38 $\times$ 2.5 mm	
L3	stripline; note 3	50 Ω	17.5 $\times$ 2.5 mm	
L4, L5	stripline; note 3	42 Ω	3 $\times$ 3 mm	
L6	2 turns enamelled 1 mm copper wire	16 nH	length 3.4 mm int. dia. 3 mm leads 2 $\times$ 5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L9	stripline; note 3	50 Ω	21 $\times$ 2.5 mm	
L10	stripline; note 3	50 Ω	34.5 $\times$ 2.5 mm	
R1	0.4 W metal film resistor	15 k Ω		2322 151 11473
R2	10 turns potentiometer	50 k Ω		
R3	0.4 W metal film resistor	140 k Ω		2322 151 11404
R4	0.4 W metal film resistor	10 Ω		2322 153 51009

Notes

1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
3. The striplines are on a double copper-clad printed-circuit board with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness $\frac{1}{32}$ inch.

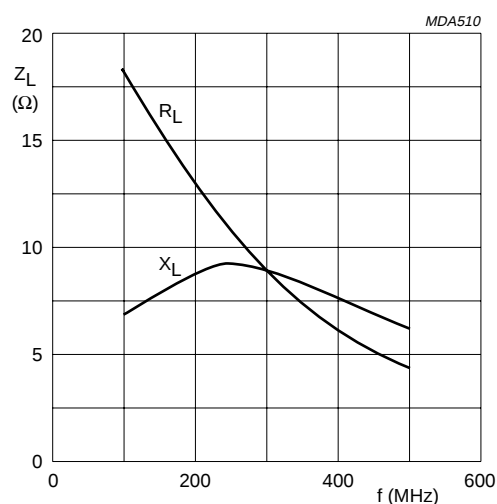
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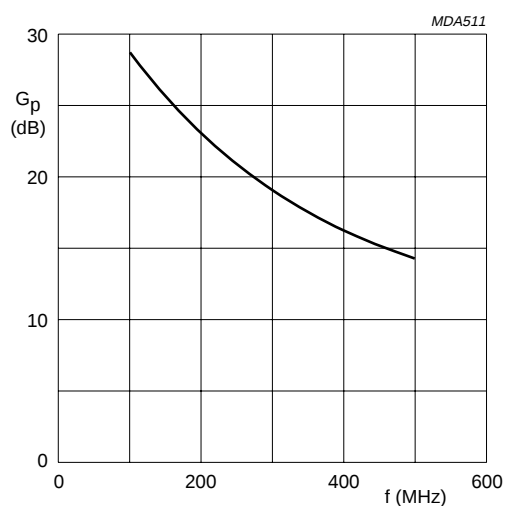
Class-B operation; $V_{DS} = 28$ V; $I_{DQ} = 40$ mA; $P_L = 20$ W.

Fig.14 Input impedance as a function of frequency (series components); typical values.



Class-B operation; $V_{DS} = 28$ V; $I_{DQ} = 40$ mA; $P_L = 20$ W.

Fig.15 Load impedance as a function of frequency (series components); typical values.



Class-B operation; $V_{DS} = 28$ V; $I_{DQ} = 40$ mA; $P_L = 20$ W.

Fig.16 Power gain as a function of frequency; typical values.

Optimum input and load impedances

Optimum input impedance: $1.2 + j4.8 \Omega$.

Optimum load impedance: $2.6 - j3.1 \Omega$.

Conditions: class-B operation; $V_{DS} = 24$ V;
 $I_{DQ} = 40$ mA; $f = 960$ MHz; $P_L = 15$ W; typical values.

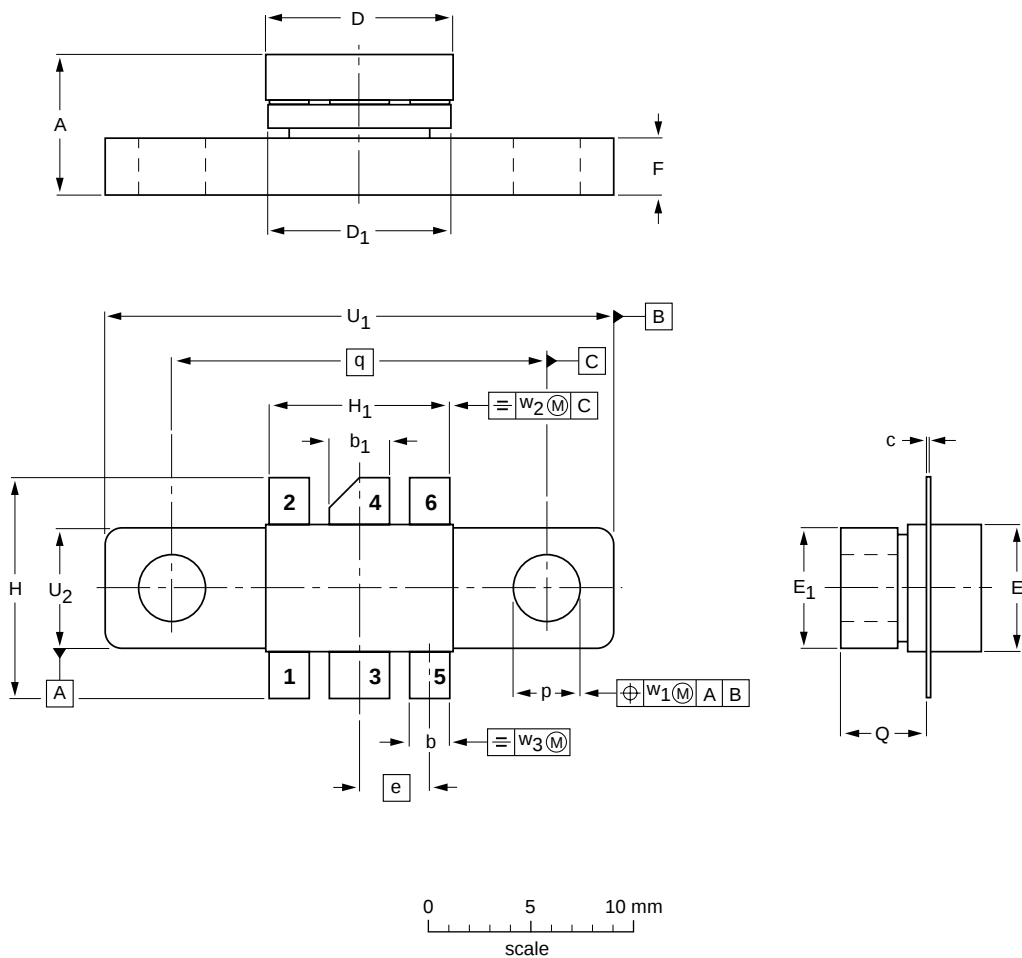
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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 6 leads

SOT171A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	b ₁	c	D	D ₁	E	E ₁	e	F	H	H ₁	p	Q	q	U ₁	U ₂	w ₁	w ₂	w ₃
mm	6.81 6.07	2.15 1.85	3.20 2.89	0.16 0.07	9.25 9.04	9.30 8.99	5.95 5.74	6.00 5.70	3.58	3.05 2.54	11.31 10.54	9.27 9.01	3.43 3.17	4.32 4.11	18.42	24.90 24.63	6.00 5.70	0.51	1.02	0.26
inches	0.268 0.239	0.085 0.073	0.126 0.114	0.006 0.003	0.364 0.356	0.366 0.354	0.234 0.226	0.236 0.224	0.140	0.120 0.100	0.445 0.415	0.365 0.355	0.135 0.125	0.170 0.162	0.725	0.980 0.970	0.236 0.224	0.02	0.04	0.01

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT171A						97-06-28

UHF power MOS transistor

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113,
Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213, Tel. +43 160 1010,
Fax. +43 160 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 200 733, Fax. +375 172 200 773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 689 211, Fax. +359 2 689 102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,
Tel. +45 32 88 2636, Fax. +45 31 57 0044

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615800, Fax. +358 9 61580920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex,
Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 23 53 60, Fax. +49 40 23 536 300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS,
Tel. +30 1 4894 339/239, Fax. +30 1 4814 240

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,
Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: see Singapore

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3,
20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108,
Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA,
Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain

Romania: see Italy

Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 1231,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000,
Tel. +27 11 470 5911, Fax. +27 11 470 5494

South America: Al. Vicente Pinzon, 173, 6th floor,
04547-130 SÃO PAULO, SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 3 301 6312, Fax. +34 3 301 4107

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Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
Tel. +41 1 488 2686, Fax. +41 1 488 3263

Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2865, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,
Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL,
Tel. +90 212 279 2770, Fax. +90 212 282 6707

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
Tel. +1 800 234 7381

Uruguay: see South America

Vietnam: see Singapore

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,
Tel. +381 11 625 344, Fax. +381 11 635 777

For all other countries apply to: Philips Semiconductors,
International Marketing & Sales Communications, Building BE-p, P.O. Box 218,
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